



TAIWAN TONGJIA OPTOELECTRONICS TECHNOLOGY CO., LTD

## 承認書

### Specification For Approval

Customer: (客戶)

Description: (產品描述)

SMD0603灯珠球头黄光

Part number: (產品型號)

TJ-S1608EX9T6ALC9Y-A5

Date: (日期)

Approved By: (客戶承認)

Prepared By: (我司承認)

| Approval | Check | Design | Sales |
|----------|-------|--------|-------|
|          |       |        |       |

核准

審核

製作

業務

Customer Service Hotline: **400-676-8616**

TEL: 0769-8662 5999      0769-8200 2226

E-MAIL : **dg@togialed.com**

FAX: 0769-8200 2227

WEB: [www.togialed.com](http://www.togialed.com)

## Features

1.6mm x 0.8mm SMT LED, 0.9mm thickness

Low power consumption

Narrow viewing angle

Package: 4000pcs/reel

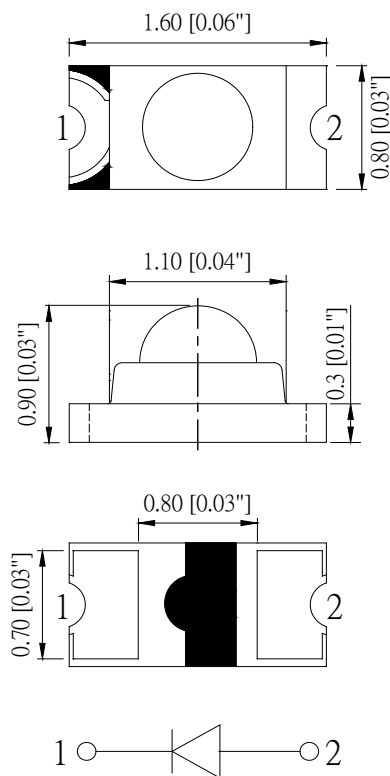
RoHS Compliant

## Applications

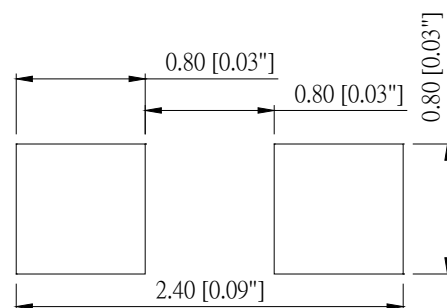
Ideal for back light and indicator

Various colors and lens types available

## Package outlinges



## Recommend Pad Layout



| Part No.              | Emitted color | Dice    | Lens color        |
|-----------------------|---------------|---------|-------------------|
| TJ-S1608EX9T6ALC9Y-A5 | Yellow        | AlGaInP | Water transparent |

### Notes:

1. All dimensions are in millimeters (inches);
2. Tolerances are  $\pm 0.1\text{mm}$  (0.004inch) unless otherwise noted.

**Absolute maximum ratings (TA=25°C)**

| Parameter                              | Symbol | Value    | Unit |
|----------------------------------------|--------|----------|------|
| Forward current                        | If     | 20       | mA   |
| Reverse voltage                        | Vr     | 5        | V    |
| Power dissipation                      | Pd     | 48       | mW   |
| Operating temperature                  | Top    | -40 ~+80 | °C   |
| Storage temperature                    | Tstg   | -40 ~+85 | °C   |
| Peak pulsing current (1/8 duty f=1kHz) | Ifp    | 60       | mA   |

Notes:

1. Duty Factor =10%, Frequency=1kHz.
2. Derate linearly as shown in derating curve.

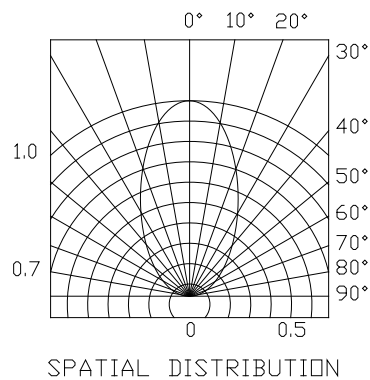
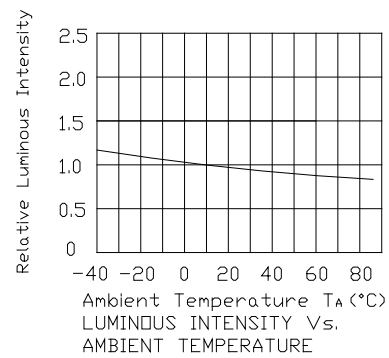
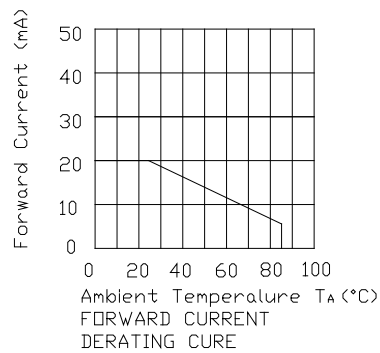
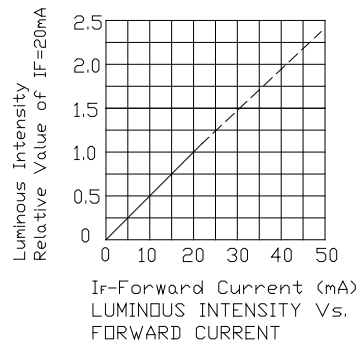
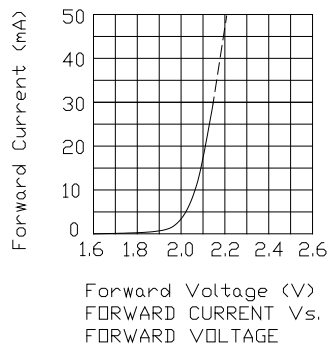
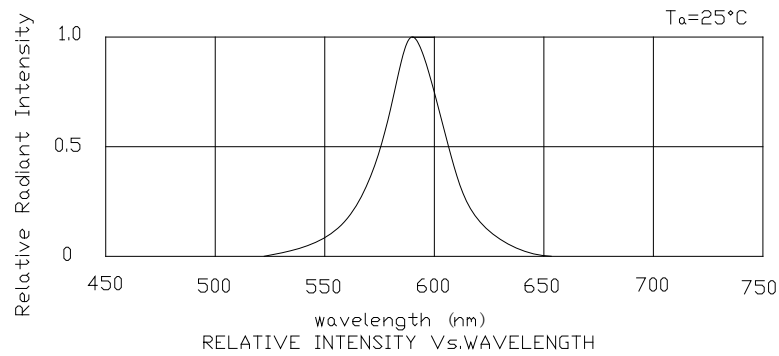
**Electro-optical characteristics (TA=25°C)**

| Parameter                   | Test Condition | Symbol           | Value |     |     | Unit    |
|-----------------------------|----------------|------------------|-------|-----|-----|---------|
|                             |                |                  | Min   | Typ | Max |         |
| Wavelength at peak emission | If=20mA        | $\lambda_p$      | --    | 591 | --  | nm      |
| Spectral half bandwidth     | If=20mA        | $\Delta \lambda$ | --    | 18  | --  | nm      |
| Dominant wavelength         | If=20mA        | $\lambda_d$      | 585   | --  | 595 | nm      |
| Forward voltage             | If= 20mA       | Vf               | 1.8   | --  | 2.4 | V       |
| Luminous intensity          | If=20mA        | Iv               | 200   | --  | 500 | mcd     |
| Viewing angle at 50% Iv     | If=10mA        | 2 $\theta$ 1/2   | --    | 60  | --  | Deg     |
| Reverse current             | Vr=5V          | Ir               | --    | --  | 10  | $\mu$ A |

Notes:

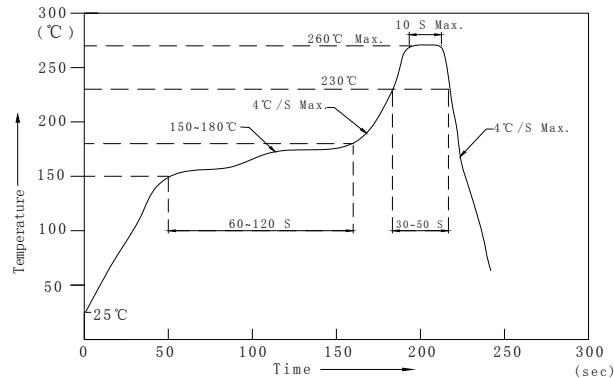
1. Luminous Intensity measurement tolerance:  $\pm 10\%$ .
2. Wavelength measurement tolerance:  $\pm 1$ nm.
3. Forward voltage measurement tolerance:  $\pm 0.1$ V.

## Optical characteristic curves



## Reflow Profile

### ■ Reflow Temp/Time



### Notes:

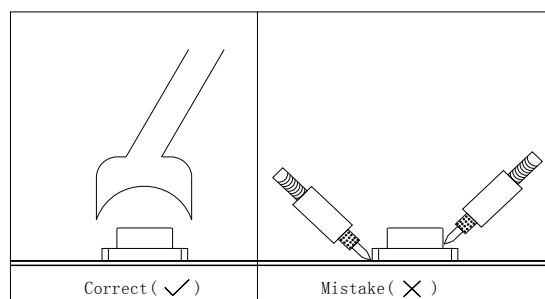
1. We recommend the reflow temperature  $245^{\circ}\text{C}(\pm 5^{\circ}\text{C})$ . the maximum soldering temperature should be limited to  $260^{\circ}\text{C}$ .
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

### ■ Soldering iron

Basic spec is  $\leq 5\text{sec}$  when  $260^{\circ}\text{C}$ . If temperature is higher, time should be shorter ( $+10^{\circ}\text{C} \rightarrow -1\text{sec}$ ). Power dissipation of iron should be smaller than 20W, and temperatures should be controllable. Surface temperature of the device should be under  $230^{\circ}\text{C}$ .

### ■ Rework

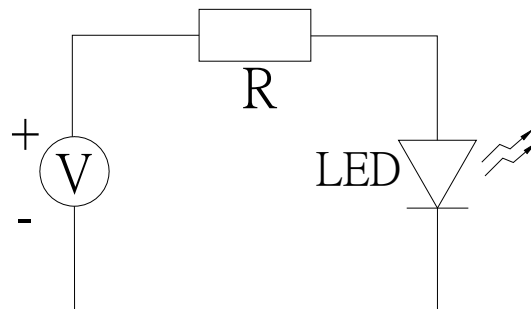
1. Customer must finish rework within 5 sec under  $260^{\circ}\text{C}$ .
2. The head of iron can not touch copper foil
3. Twin-head type is preferred.



- Avoid rubbing or scraping the resin by any object, during high temperature, for example reflow solder etc.

## Test circuit and handling precautions

### ■ Test circuit



### ■ Handling precautions

#### 1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

#### 2. Storage

2.1 It is recommended to store the products in the following conditions:

Humidity: 60% R.H. Max.

Temperature : 5°C~30°C(41°F~86°F)

2.2 Shelf life in sealed bag: 12 month at <5°C~30°C and <30% R.H. after the package is Opened, the products should be used within a week or they should be keeping to stored at  $\leq 20$  R.H. with zip-lock sealed.

#### 3. Baking

It is recommended to baking before soldering when the pack is unsealed after 72hrs. The Conditions are as followings:

3.1  $60 \pm 3^\circ\text{C}$  x(12~24hrs) and <5%RH, taped reel type

3.2  $100 \pm 3^\circ\text{C}$  x(45min~1hr), bulk type

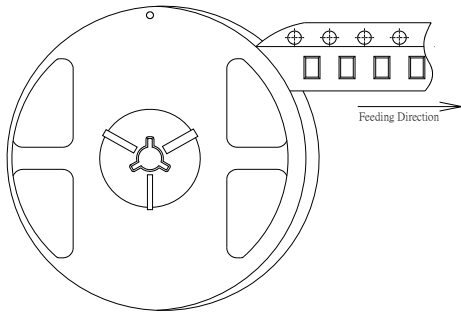
3.3  $130 \pm 3^\circ\text{C}$  x(15~30min), bulk type

**Test items and results of reliability**

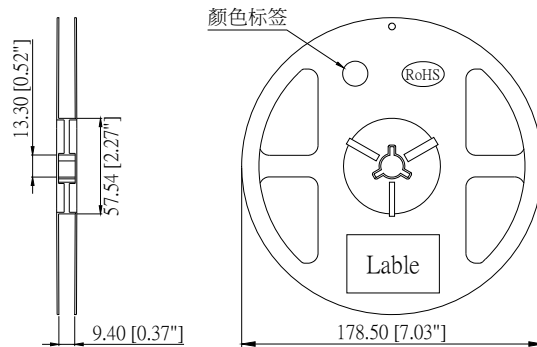
| Type                   | Test Item                    | Test Conditions                 | Note      | Number of Damaged |
|------------------------|------------------------------|---------------------------------|-----------|-------------------|
| Environmental Sequence | Temperature Cycle            | -40℃ 30min<br>↑ ↓<br>80℃ 30min  | 100 cycle | 0/22              |
|                        | Thermal Shock                | -40℃ 15min<br>↑ ↓<br>80℃ 15min  | 100 cycle | 0/22              |
|                        | High Humidity Heat Cycle     | 30℃ ⇄ 65℃<br>90%RH 24hrs/1cycle | 10 cycle  | 0/22              |
|                        | High Temperature Storage     | Ta=80℃                          | 1000 hrs  | 0/22              |
|                        | Humidity Heat Storage        | Ta=60℃<br>RH=90%                | 1000 hrs  | 0/22              |
|                        | Low Temperature Storage      | Ta=-40℃                         | 1000 hrs  | 0/22              |
| Operation Sequence     | Life Test                    | Ta=25℃<br>IF=20mA               | 1000 hrs  | 0/22              |
|                        | High Humidity Heat Life Test | 60℃ RH=90%<br>IF=10mA           | 500 hrs   | 0/22              |
|                        | Low Temperature Life Test    | Ta=-40℃<br>IF=20mA              | 1000 hrs  | 0/22              |

# 1608 Series SMD Chip LED Lamps Packaging Specifications

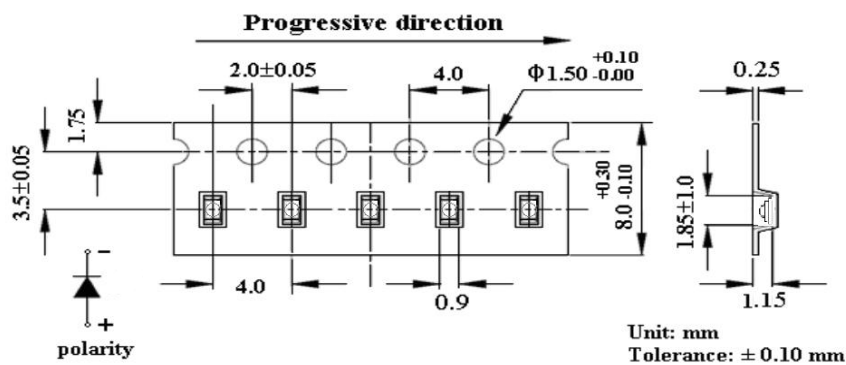
- Feeding Direction



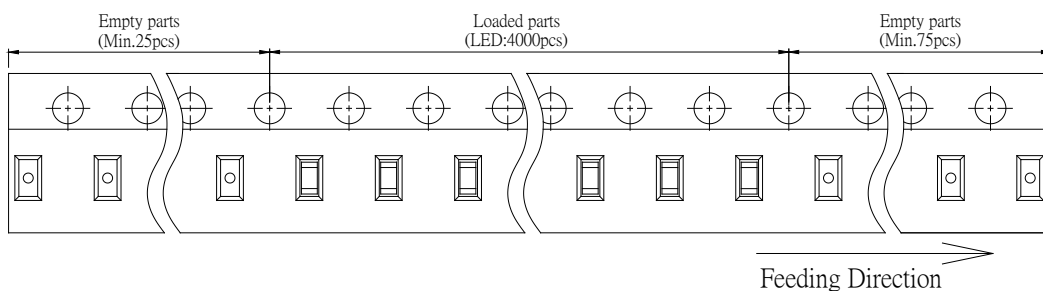
- Dimensions of Reel (Unit: mm)



- Dimensions of Tape (Unit: mm)



- Arrangement of Tape



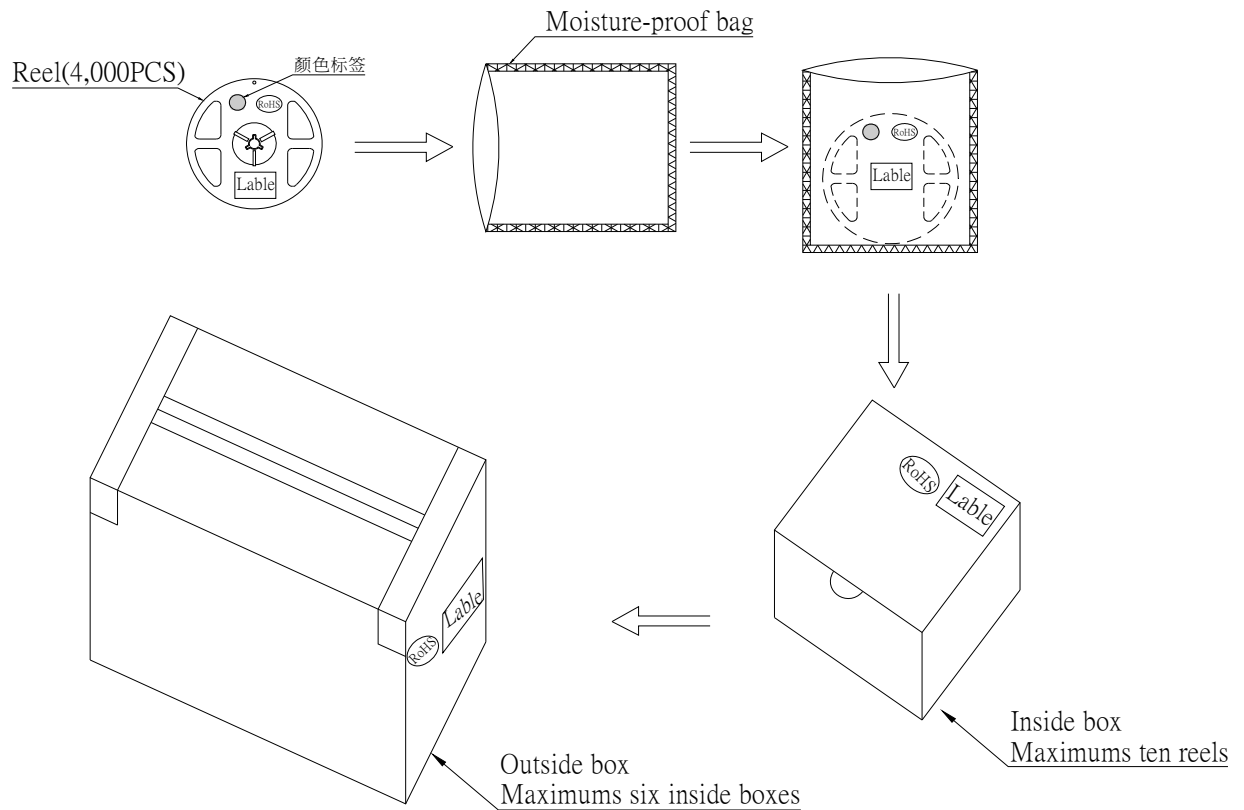
Notes:

1. Empty component pockets are sealed with top cover tape;
2. The maximum number of missing lamps is two;
3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications.
4. 4,000 pcs/Reel.



## 1608 Series SMD Chip LED Lamps Packaging Specifications

- Packaging specifications



### Notes:

Reeled products (numbers of products are 4,000pcs) packed in a seal off moisture-proof bag along with a desiccant one by one, Seven moisture-proof bag of maximums (total maximum number of products are 40,000pcs) packed in an inside box (about size: 240 x 220 x 120mm) and four inside boxes of maximums are put in the outside box (about size: 460mm x 246mm x 250mm) Together with buffer material, and it is packed. (Part No., Lot No., quantity should appear on the label on the moisture-proof bag, part No. And quantity should appear on the label on the cardboard box.) The number of the loading steps of outside box (cardboard box) has it to three steps.